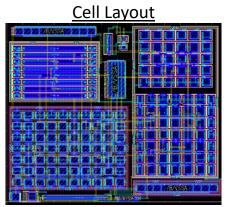


## I<sub>BIAS</sub>11

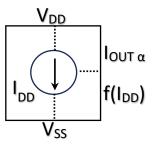
Ultra-Low-Power Proportional to Absolute Temperature (IPTAT) Bias Current Source. Proof of silicon with typical/preliminary measurements available. (Please contact sales@ailinear.com)

Parameter	Typical	Condition
	Spec	
I <sub>DD</sub> (nA)	12	V <sub>DD</sub> =2v, Temperature = 27C
V <sub>DD</sub> Low (v)	0.8	V <sub>DD</sub> sweep 0v→2.2v, Temperature = 27C
V <sub>DD</sub> High (v)	2	V <sub>DD</sub> sweep 0v→2.2v, Temperature = 27C
TC (%/C)	0.4	V <sub>DD</sub> =2v, ΔT ~30C
VC (%/V)	0.4	V <sub>DD</sub> sweep 1v→2.2v, Temperature = 27C

\*See Disclaimer\*







Cell Size ~68µm×50 µm in TSMC 180nm CMOS

## Features:

- Patented
- Programmable (pre or post silicon) I<sub>OUT</sub> that tracks I<sub>DD</sub>
- Tiny CMOS (~68μm×50 μm) bias current Intellectual Property (IP) cell operating in subthreshold with ultra-low current consumption IDD (typical 12nA)
- Large value but tiny active bias resistor (R<sub>PMOS</sub>) as a function of PMOSFET keeps I<sub>DD</sub> ultra-low
- Most suitable for SoC whose analog (e.g., oscillator, comparator, ADC) performance best correlates with PMOSFET parameters
- Suitable for SoC where I<sub>BIAS</sub> is more optimized when V<sub>SS</sub> coupled with PTAT Kirkoff Voltage Loop (KVL)
- Utilizing PTAT loop with NMOSFETs needing 1V<sub>GS</sub>+2V<sub>DS</sub> for lower V<sub>DD</sub> operating range
- I<sub>DD</sub> and I<sub>OUT</sub> absolute value mostly a function of PMOSFET mobility (μ) inherently more stable to help narrow I<sub>DD</sub> variation over fabrication process corners
- Based on 180nm digital CMOS at TSMC and portable to smaller fabrication nodes.